

Advanced Test Equipment Rentals www.atecorp.com 800-404-ATEC (2832)



WORLD-WIDE LEADERS IN LOCALIZED TEMPERATURE CONTROL SOLUTIONS

TEMPTRONIC Complete Thermal

The TP04000 Series ThermoStream Systems combine advanced mechanical design with new developments in system control, display, programming and thermal performance for the testing of components, hybrids, modules, small assemblies and printed circuit boards at temperature from -75°C to +225°C with 0.1°C precision and repeatability.

The system has the flexibility to readily adapt to the requirements of both the production and engineering environments. Easy to operate and program in manual, semi-automatic or automatic mode, the TP04000 interfaces to most testers and host computers for complete ATE integration.

Long term product support includes thorough documentation, extensive application support and a worldwide customer service network providing fast response to customer inquiries.

A complete line of thermal accessories provide the TP04000 with the versatility to meet the many localized temperature control applications in the industry today. For MilSpec qualification, production testing, reliability testing, characterization, environmental stress screening, and design verification, the TP04000 Series ThermoStream Systems provide a complete thermal test solution.





The Ultimate in User-Friendly Setup and Control

Operate the system simply by the *Operator*

Easy to use *Operator's Mode* with password protection assures test consistency.

Control Module (OCM) function keys and numeric keypad. Intuitive menus and on-line context sensitive help screens make system control and programming easy.

The **full screen display** on the OCM provides complete, up-to-the-moment information, including air and/or DUT temperatures, all programmed values, up to 12 temperature setpoints, ramp, soak and cycle information, system operational status and error messages. All information is displayed simultaneously in alphanumeric and graphic formats.

Two modes of manual operation provide the flexibility to make the system perfectly suited for both production and engineering environments.

The *Operator's Mode* controls the system at the touch of a single button, for added efficiency in the production type environment. Password protection can be set to prevent the user from modifying programmed test set-up files for test security.

The *Engineering Mode* enables the operator to take full advantage of the system's programming capabilities. A variety of temperature test routines can be easily created, run and filed using the intuitive menus. All programming features and defaults, including data logging, hardcopy reports and "At Temperature" Windows can be specified in this mode.



Fully Compatible with any ATE or Rack and Stack Test System

IEEE-488, TTL Level Start-Test/End-of-Test and optional RS232 interfaces are compatible with any tester or host computer for complete integration into the ATE test environment. All communication I/O interfaces allow unrestricted access to all TP04000 functions from head manipulation to automatic flow control for total programming flexibility and truly unattended operation.

The test programmer can easily include temperature as a functional test and design variable within the test program. The System's independent programmability. multiple test set files and non-volatile memory assure that all TP04000 system capabilities can be used without burdening or reducing the processing speed of the tester CPU.

The wide temperature range (-75°C to +225°C)
exceeds Mil Spec requirements.

Automatic Air Flow Control optimizes the
system's high air flow rate, up to 18 SCFM, without
requiring manual adjustments for the fastest device
temperature transition times. Even larger devices,
printed circuit boards and high power hybrids are
brought to temperature with speed and precision.

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Full featured *Engineering Mode* for ultimate system flexibility.

Optimized Test Accuracy

Test accuracy and throughput is assured by setting the "At Tem-

perature" Windows, which can be defined from ± 0.5 °C to ± 9.9 °C around the desired test temperature.

seconds between +125°C and 55°C, whether heating or

cooling in continuous cycle mode.*

For "real time" temperature precision, the temperature sensing of the airstream is done at the TP04000 output nozzle, within 1 cm of the test device, assuring that the air affecting the test device is typically within 1.0° C of the displayed temperature.

Temperature accuracy and stability for all device types, package styles and power levels is provided by the easy to use automated electronic calibration routine.





Develop unlimited test set-up files manually or via IEEE-488 and RS232.

Repeatable Test Results and Reduced Set-up Time

Create custom temperature

profiling routines including adjustable ramp rate, soak time and cycle sequences with up to 12 test temperatures using User-friendly menus. Unlimited set-up files and thermal profile routines can be developed, filed and retrieved instantly using the 3.5 inch floppy disk drive.

For added flexibility in meeting specific test requirements, defaults such as "At Temperature" windows, high and low temperature limits, calibration values, IEEE-488 address, test device settling time and tunable DUT control constants can be easily adjusted by the programmer in the *Engineering Mode* using intuitive windows. **Non-volatile memory** retains all programmed defaults and information when the system is turned off or unplugged.

Test programs may be set up and run in the manual modes of operation or via IEEE-488, TTL Level ST/EOT/SFF or optional RS232 remote interfaces. Connectors are provided for a keyboard and monitor.



Convenient Coupling to the Test Fixture

The TP04000 is supplied with an easy to use **Thermal Interface Kit** containing sufficient materials for coupling to several test fixtures.

Temperature controlled purge air at the test site insures that the test socket and test fixtures are maintained at close to room temperature whether testing at extremely high or low temperatures to prevent moisture, frost or overheating

of tester electronics.

Highly repeatable accuracy is accomplished by precision pneumatics raising and lowering the thermal test head to

Personal and Environmental Safety

The TP04000 is an environmentally safe alternative to flourocarbon sprays and baths and pressurized cooling gas tanks.

"Power On" indicator, Emergency "Off" button, low air pressure and flow cut-outs, redundant overheat protection and "At Temperature" and error conditions are provided. An optional red, blue/amber and green status light sits atop the unit, so that system status can be verified from across the test floor.

Large, locking casters and an integral push bar make transporting the system between test sites safe and easy. Leveling feet assure system stability even on uneven floor surfaces.





Data Logging and Convenient Hardcopy Report Generation

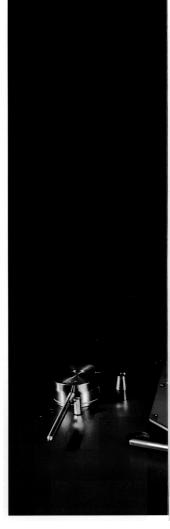


Review stored and logged thermal performance data on the *Review Temperature Data Screen*.

Data Logging Mode and the user-friendly Report Generator assist the user in saving data and creating reports quickly and easily for test verification, documentation, archives and analysis.

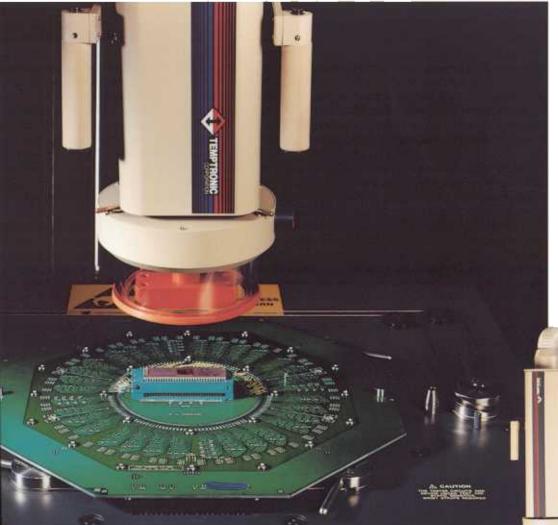
User designed reports and graphs present temperature test results based on various test parameters. "Real time" temperature performance data can be reviewed on screen and graph parameters can be adjusted to analyze any time period more closely. The *Parallel Printer Port Option* can be used to generate hard copy reports of the test data and set-up parameters.

Continuous data logging of several hours of thermal performance data with continuous date and time stamping can be retained in RAM. 36 or more hours of continuous information can be stored on a single 3.5" floppy disk.



and from the DUT site. The adjustable arm firmly supports the thermal head assembly at the test site assuring proper alignment.

All thermal caps may be removed and replaced without tools. An optional footswitch is available for hands-free raising and lowering of the thermal head assembly to and from the test site.



DUT Control Assures Component Temperature Accuracy

DUT (Device Under Test) patented Dual Loop Control Mode* provides direct control of the test device case temperature. The DUT control is user-tunable to optimize throughput for any package size.

The device temperature is brought as close as possible to the desired test temperature, with minimal offset, by the system using a temperature sensor located on the test socket in contact with the DUT or attached to the device case. The TP04000 will accept type "K" and type "T" thermocouple and optional 1000 ohm RTD external DUT sensors.

A stable DUT temperature is maintained in DUT control mode. The system will react to any change in the power dissipation level in the test device and will automatically compensate through air temperature control. In DUT mode, the operator can also manually fine tune the control constants to match the mass of the device for the best

compromise between minimal overshoot and fastest temperature transition time.

ESD Protection

The TP04000 has been designed to provide ionically balanced air **free of static charge**, regardless of the test temperature. When coupled with the optional conductive shroud kit for interfacing to the tester socket, an ESD Protected environment is assured.

Maximum "Up Time"

Designed for reliability and easy service, the durable mechanical design of the TP04000 makes the system consistently reliable in 24 hour/day production environments. Optimum system performance is assured by the automated calibration mode, start up diagnostics and service diagnostics.

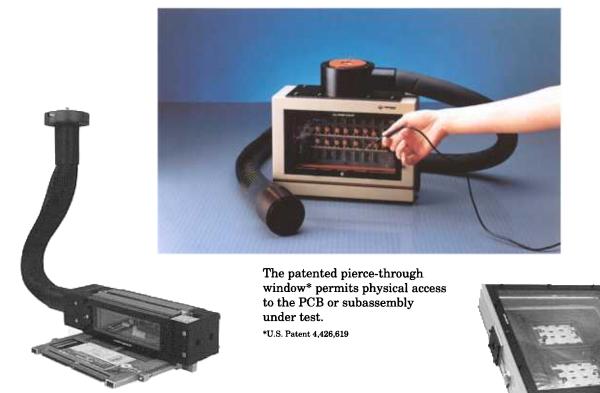
The Modular design of the TP04000 allows for fast, easy service by factory trained local service representatives worldwide, the best service support network in the industry for this type of equipment.

*U.S. Patent 4,734,872

Precise Temperature Control for Printed Circuit Board, Component Arrays, and Electronic and Electro-mechanical

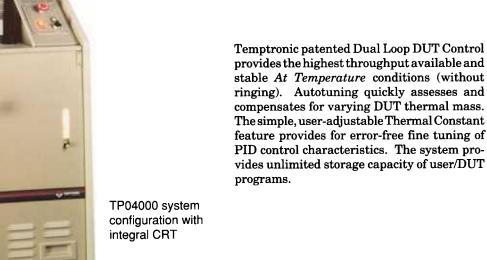
Subassemblies

Custom thermal test enclosures for test, characterization and failure analysis of PCBs, component arrays and small subassemblies at temperature allow manual test probing of the device through patented pierce-through, fog-free windows.

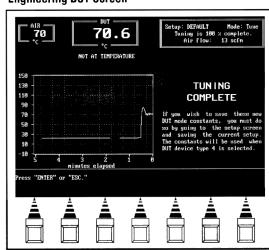


Custom enclosures can be configured to meet specific test requirements for PCB and electronic and mechanical subassemblies.

Custom PCB thermal test enclosures are available for both edge-connector and in-circuit bed-of-nails PCB test applications.



Engineering DUT Screen



TP04000 ThermoStream System

High capacity, programmable temperature control for testing and characterizing components, hybrids, modules and printed circuit boards at temperature from -75°C to +225°C.

SPECIFICATIONS

Temperature Range¹ Mechanical Arm:

-70°C to +225°C (cycling) -65°C to +225°C (steady state)

¹CFC-free System is available - low temperature in range will degrade +5℃.

Air Flow

Up to 18 SCFM while temperature transitioning. Microprocessor regulated for optimum High Speed Head: +125°C to -55°C 5 sec Standard Head: +125°C to -55°C 22 sec

system performance. Also user-settable upper limit by keypad or remote control.

Temperature Accuracy ±1.0°C (when calibrated against a transfer standard)

Temperature Set and

Typical Transition Rate

Display Resolution

0.1%

Non-volatile Memory

Battery back-up retention of parameters

Controller Type

Microprocessor-based PID (Proportional, Integral, Derivative)

Local Control

Keypad entry of parameters and selection of operating mode, setpoint

Remote Interface Ports

RS232C Serial (option)

Programmer's Keyboard: AT compatible

IEEE-488 Parallel Bus

Parallel Printer: IBM or EPSON compatible (option)

EGA Monitor

Handler Interface

Start Test/End of Test with Stop on First Fail (5-12 VDC Pulse; user-settable polarity)

Remote DUT Sensors

Type T thermocouple supplied; Type K thermocouple supplied; 1000 ohm RTD optional

Status Indication

On-screen and at-communication I/Os (separate visual indicator)

Overheat Protection

235°C Separate circuit. (Also user-settable high and low air temperature limit) Supplies -70°C dew point air from a minimum 80 PSI source at 12 SCFM flow rate

Drver Dimensions

System Unit- (5.2 sq. feet), 24" (61 cm) wide x 31" (79 cm) long x 41" (104 cm) high

Weight

System Unit

Arm and Thermal Head Assembly -

Mechanical Arm Configuration

350 lbs. (159 kg) 75 lbs. (35 kg)



Power Requirement 220V AC, nominal, single phase, 50/60 Hz, 15 amps (standard) - Buck/Boost Transformer is provided for supply voltage outside the standard power requirement.

FACILITIES PREPARATION

Compressed Air Input Requirement

80 to 110 PSIG with air dryer (100 PSI nominal2) 70 to 110 PSIG without air dryer (100 PSI nominal2)

@ Flow Rate

8 to 24 SCFM with air dryer (16 to 24 SCFM recommended provides optimum system performance) 5 to 21 SCFM without air dryer

@ Dew Point

< +10°C at 80 PSI with air dryer < -75°C at 80 PSI without air dryer

Air Input Temperature +20°C to +28°C (+22°C nominal2)

Operating Temperature

+20°C to +28°C (+22°C nominal2)

Humidity

0 to 60% (45% nominal2)

Noise level

62 to 63 dBA

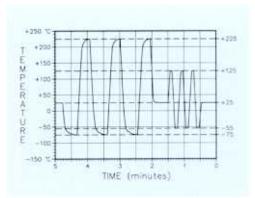
²Reduced performance may be encountered at operating environments less than or greater than nominal.



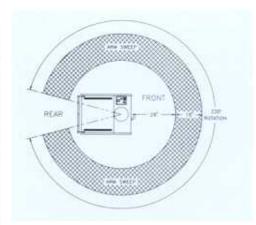
These specifications are valid for the standard product and are subject to change without notice. Applications requiring modification of electrical, thermal, or mechanical characteristics should be discussed with the factory for possible accommodation at addi-

PART NO. SL10070 R/B

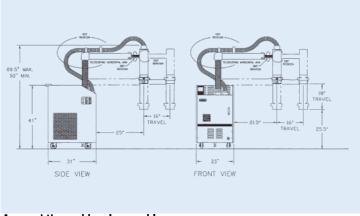
Printed in U.S.A.



Performance graph of temperature vs time showing full system range -75°C to +225°C and mil spec range -55°C to +125°C continuous cycle transition



Rotation of Arm



Arm and thermal head assembly

All dimensions are approximate.

Complete Thermal Test Solutions



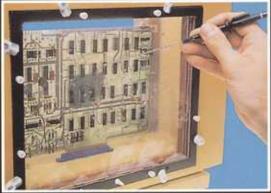
ThermoStream Systems for testing and characterizing components, modules and small printed circuit boards.



ThermoMap™ thermal imaging system for full color mapping of the temperature distribution of a device with 1 micron spatial and 0.1°C thermal resolution; for use in design, analysis and hot spot location.



ThermoFixture for testing hybrids, MCMs, modules, PCBs and other devices in a custom enclosure with fixturing for integration with ATE test systems.



ThermoZone Systems for testing, in-circuit probing and troubleshooting component arrays, burn-in boards, printed circuit boards and small electronic and electromechanincal subassemblies.



ThermoChuck Systems for probing wafers, chips, hybrids and other flat devices at hot and cold temperature.



ThermoSocket Systems for testing and locating micron size defects on chips even at 30 microwatt power levels.



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